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**Transmitter Specifications and COM for 50GBASE-CR updated Mike Dudek Cavium** Tao Hu Cavium

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## Introduction

- The specification methodology for the Copper Cable and backplane clauses creates a closed budget by specifying the cable/backplane with COM and calibrating the Rx Interference Tolerance test with COM.
- This relies however on
  - The specifications for the Tx matching (or being more stringent) than the Tx that is used in COM in the cable/backplane test, or there being a difference between the COM value used to specify the cable and the COM value used for calibrating the RX interference tolerance test.
- This presentation is an update to the presentation made to the ad-hoc on 1/10 that investigated the performance of the Tx used in COM at TP2 and compared this with the specifications at that point.
- It proposes to align the package parameters in the 50GBASE-CR clause with those used in the 50GBASE-KR clause as it is expected that the same ASIC will be used for both, and proposes the use of a 100 Ohm PCB trace in the host (rather than the existing 109.8 Ohm) in order to not encourage cable vendors to tune their cables to a higher impedance to obtain better COM results.
- This presentation is related to comments i-161, i-162, and i-163



## **Differences to ad-hoc presentation.**

- Corrected the proposal as sent to the reflector where there were typos and an omission.
- Added some additional information, including COM results on two additional cables.
- Clarified some wording.



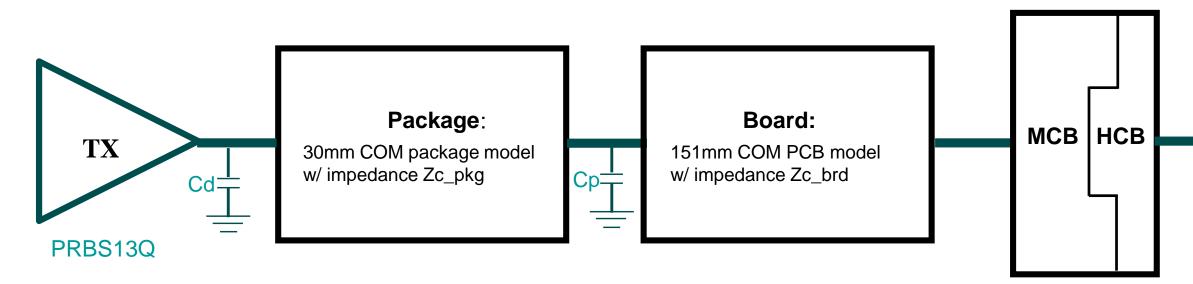
## Methodology

- The COM channel up to the Tx test points was duplicated as close as possible in Matlab.
- The output waveform at the test point was generated in Matlab using Tx with Av=0.4V and using the risetime used in COM. Absolute voltages can be scaled for other values of Av.
- The resulting waveform was then analyzed using the Tx test methodology to determine the Tx parameters which are compared with the Tx specifications. The effect of RLM was also investigated. Nv=13 was used to calculate Vf the steady state voltage to align with 120D and 50GBASE-KR.
- This was repeated changing the transmitter package to match the one being specified in 50GBASE-KR and using a 100 Ohm Host PCB trace impedance.
- COM was also calculated for five representative cables using both the parameters in draft 3.0 and these changed parameters.



## **Transmitter simulation block diagram at TP2**

**QSFP** mated test fixture (measured S parameters)



Transmitter plus package, board, QSFP mated test fixture and 33GHz 4<sup>th</sup>-order BT filter



### Scope w/ 33G 4<sup>th</sup>-order BT filter

### 53.125Gbs PAM4 transmitter characteristics @ TP2 w/o TX equalization: measured w/ 4<sup>th</sup> order 33GHz BT filter

					S	imulated P	RBS13Q @	TP2			
Parameters	D3.0 SPEC (Table 136-11) and Table 136-16	Gau	ssian TX Filto	er Risetime 2	L2ps; 30mm	0.4V	Units				
Rd	55		55			50			50		ohm
Zc_pkg	90		90			95			95		ohm
Zc_brd	109.8		109.8			109.8			100		ohm
EB+EC		0	0	0.1	0	0	0.1	0	0	0.1	N/A
RIm	>=0.95	0.947	0.997	0.947	0.947	0.997	0.947	0.947	0.997	0.947	N/A
Sigma-e		0.094	0.093	1.498	0.099	0.098	1.582	0.093	0.092	1.587	mV
Vf (steady-state voltage)	0.34V=< Vf <=0.6V	0.341	0.341	0.341	0.359	0.359	0.359	0.36	0.36	0.36	V
Pmax (Linear fit pulse peak)		0.165	0.165	0.165	0.174	0.174	0.174	0.174	0.174	0.174	V
Differential Peak to Peak Voltage	<=1.2	0.653	0.654	0.654	0.69	0.69	0.69	0.692	0.692	0.692	V
Pmax/Vf	>=0.49	0.482	0.482	0.482	0.484	0.484	0.483	0.484	0.484	0.484	N/A
<i>SNR<sub>isi</sub></i>	36.8	31.196	31.208	31.19	32.098	32.091	32.09	32.238	32.229	32.23	dB
SNDR (@ Sigman = 0)		64.86	64.976	40.814	64.85	64.965	40.815	65.476	65.597	40.823	dB
SNDR (TX_SNR=32.5dB)	>=33.3	32.497	32.498	31.903	32.497	32.498	31.903	32.498	32.498	31.904	dB

PAM4 Levels: L0=-1;L1=(-1+EB)/3;L2=(1+EC)/3;L3=1

### Linear fitting: Dp=3;Nb=12;Np=200;Nv=13



## **Conclusions on waveform simulations.**

- The values of SNDR and SNRisi in draft 3.0 would fail the Transmitter used in COM and are therefore more stringent than they need to be.
- The calculations used Nv=13 (same as 120D.3.1.4 and clause 137) by reference). As defined in draft 3.0 the value of Nv would be infinite so that should be changed.
- The Pmax/Vf ratio is not significantly affected by the various changes and the existing value of 0.49 does not need to be changed. (comment i-161) (provided Nv=13 is used).
- The value of Vf in draft 3.0 isn't appropriate for the value of 0.45 for Av. Av and Vf should be changed based on the values of Rd and Av used (and Nv) to better correlate to each other and to the **50GBASE-KR** specification.



## **COM results**

				3	302.3b	02.3by COM				802.3cd/D3.0 COM						
	Loss (dB) @ 12.89 GHz	Loss (dB) @ 13.28 GHz	CA-2	CA-25G-N		CA-25G-S		CA-25G-L		Table 136-15 Rd=55 Zc_pkg=90 Zc_brd=109.8		Table 137-5 Rd=50 Zc_pkg=95 Zc_brd=109.8		137-5 =50 kg=95 d=100		
			Case 1	Case 2	Case 1	Case 2	Case 1	Case 2	Case 1	Case 2	Case 1	Case 2	Case 1	Case 2		
TE QSFP to QSFP 3m 25 AWG	15.35	15.42	3.35	2.56	4.69	3.88	6.70	6.00	5.05	4.60	5.04	4.54	5.40	4.82		
FCI QSFP to Quad SFP 3m 26 AWG	17.59	17.73	2.57	1.58	4.18	3.24	6.21	5.33	4.34	3.80	4.39	3.62	4.54	3.72		
Molex zQSFP to zQSFP 3m 26AWG	14.12	14.41	4.16	3.22	5.56	4.63	7.56	6.63	6.06	5.42	6.04	5.32	6.23	5.55		
Amphenol QSFP to QSFP 3m 26AWG	14.42	14.74	3.63	2.93	5.07	4.15	6.99	6.33	5.43	5.00	5.55	5.02	5.80	5.18		
TE QSFP to Quad SFP 3m 28 AWG	16.61	17.16	3.11	2.00	4.44	3.39	6.60	5.58	4.90	4.31	4.85	4.11	4.99	4.21		

Max Allowed Cable loss in draft 3.0 at 13.28GHz is 17.16dB.



## **Overall Conclusions.**

- The draft 3.0 cable COM specification is more relaxed than that for the 25GBASE-CR-N and 25GBASE-CR-S cables implying that some tightening would be possible while maintaining the 3 meter objective.
- Changing the parameters to match the 50GBASE-KR specification and the host PCB to 100 Ohm is desirable but doing just that would relax the cable specification further. Also it would require tighter specifications on the Tx than the existing worst case values making it difficult to make host Tx's.
- Note that there isn't any margin for Tx host noise (or impedance mismatch if the PCB is changed to 100 Ohm) as neither are included in the COM calculations.
- The next slide lists the proposed changes that will close the budget, correcting existing issues and making the desired changes.

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## **Proposed Changes. (These supercede those in my** comments and has corrections since the ad-hoc)

- COM parameters
  - RD=50 Ohms (was 55)
  - Zc package = 95 Ohm (was 90 Ohm)
  - Av/Afe= 0.415 (was 0.45)
  - Ane=0.604 (was 0.63)
  - Add an exception that Zc for the PCB = 100 Ohm (on page 236 line 39 change "parameter values given in Table 92-12" to "parameter values given in Table 92-12 except that Zc=100 Ohm" (was 109.8 Ohm)
- COM pass/fail criterion 3.3dB for Cable test (was 3.0dB), 3.0dB for interference calibration (no change).
- TX specifications
  - Add a sentence to 136.9.3.1.2 stating that Nv=13. (was effectively infinite)
  - Vf(min) = 0.354V (was 0.34V)
  - SNRisi=31.2dB (was 36.8dB)
  - SNDR=32dB (was 33.3dB)





## Back-up.

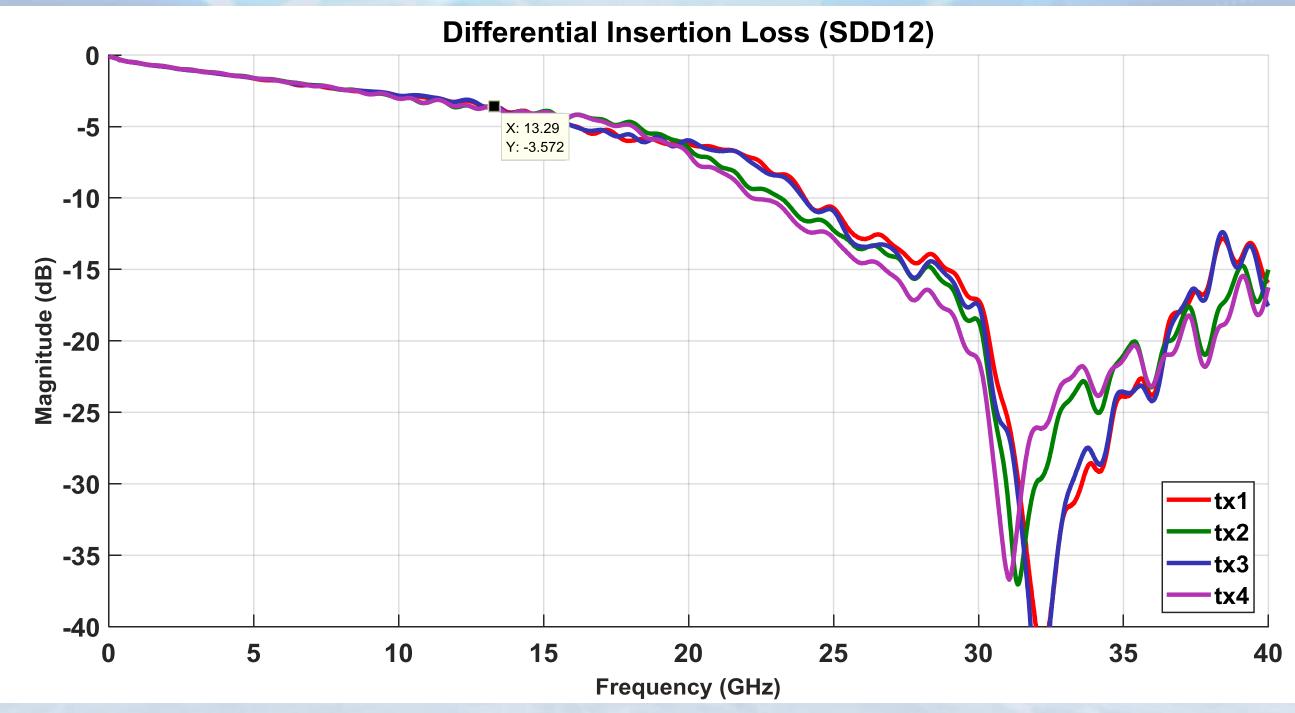




### Channel performance.

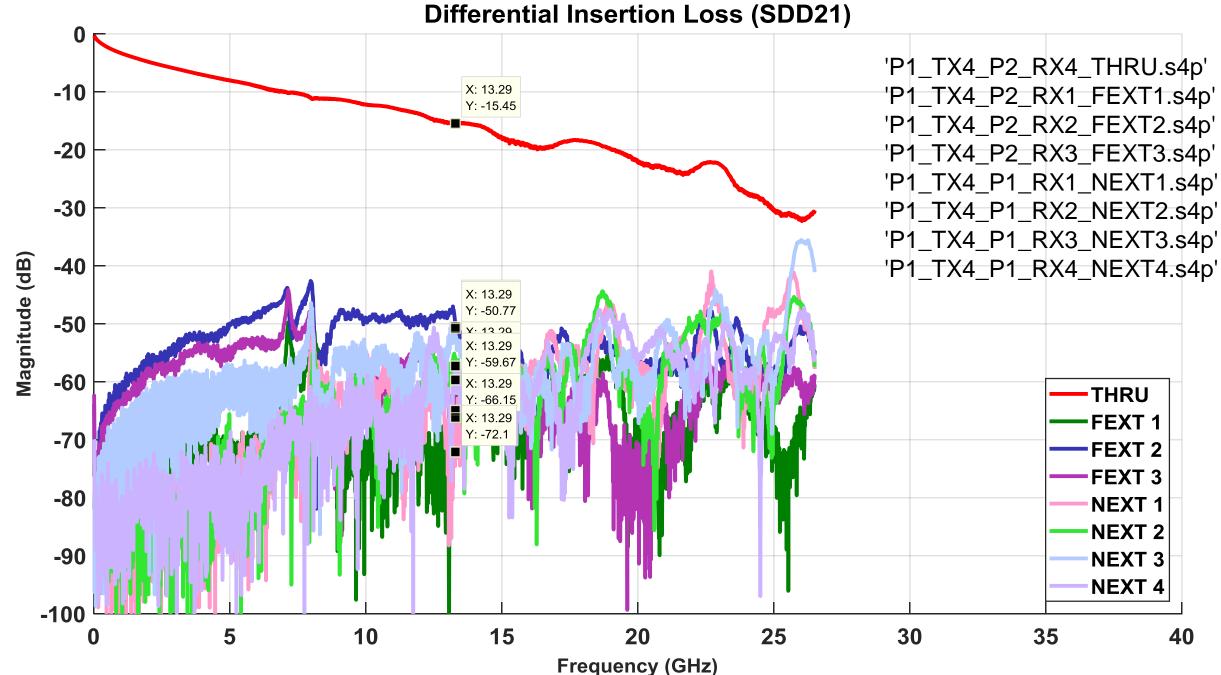


## **QSFP** mated test fixture





### **TE QSFP to QSFP cable 3m 25awg cable**

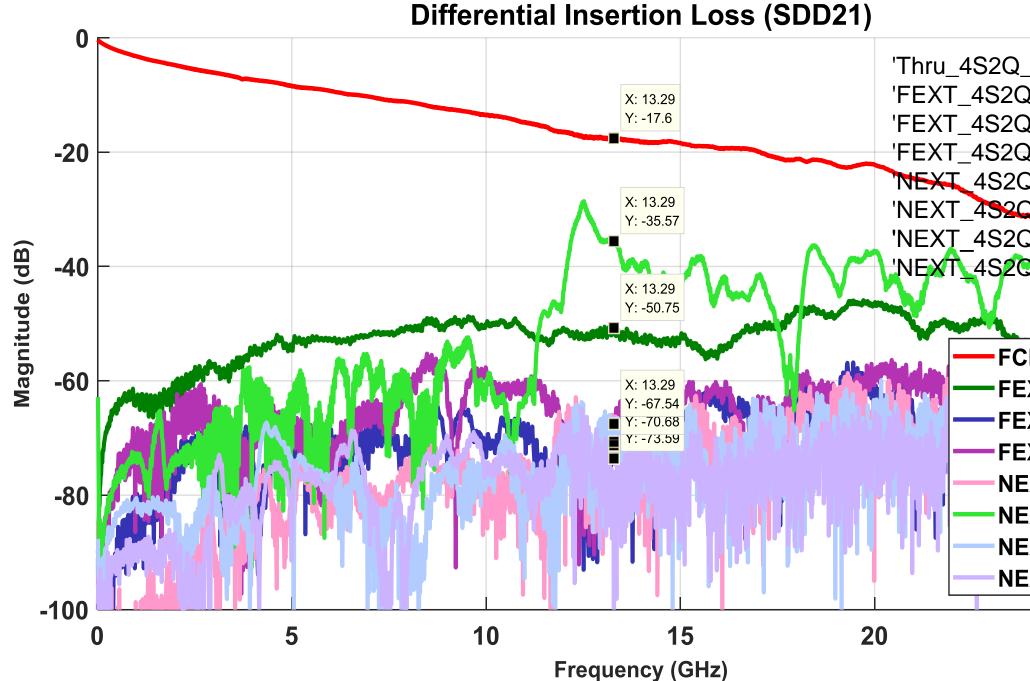


Transmitter Specifications and COM for 50GBASE-CR updated - dudek\_3cd\_01\_0118



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## FCI QSFP to Quad SFP 3m 26 AWG cable at 55C

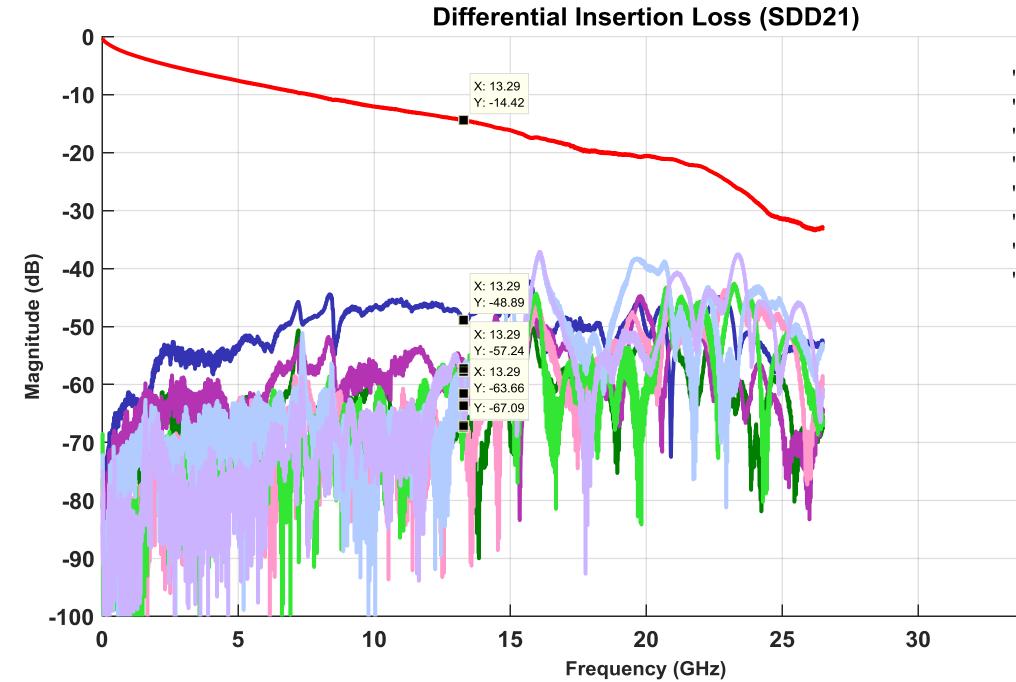




'Thru\_4S2Q\_55C\_C1\_Pr\_10\_to\_Pr\_2.s4p' 'FEXT\_4S2Q\_55C\_C1\_Pr\_9\_to\_Pr\_2.s4p' 'FEXT\_4S2Q\_55C\_C1\_Pr\_11\_to\_Pr\_2.s4p' 'FEXT\_4S2Q\_55C\_C1\_Pr\_12\_to\_Pr\_2.s4p' 'NEXT\_4S2Q\_55C\_C1\_Pr\_5\_to\_Pr\_2.s4p' 'NEXT\_4S2Q\_55C\_C1\_Pr\_6\_to\_Pr\_2.s4p' 'NEXT\_4S2Q\_556\_C1\_Pr\_7\_to\_Pr\_2.s4p' 'NEXT\_4S2Q\_55C\_C1\_Pr\_8\_to\_Pr\_2.s4p'

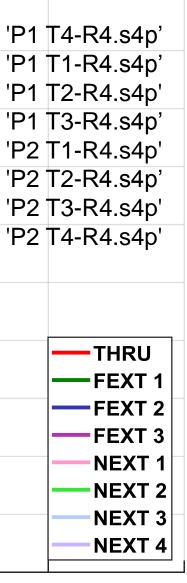
3m 26 AWG	
XT 1	
XT 2	
XT 3	
EXT 1	
XT 2	
EXT 3	
EXT 4	
25	

## Molex zQSFP to zQSFP 3m 26AWG



Transmitter Specifications and COM for 50GBASE-CR updated - dudek\_3cd\_01\_0118

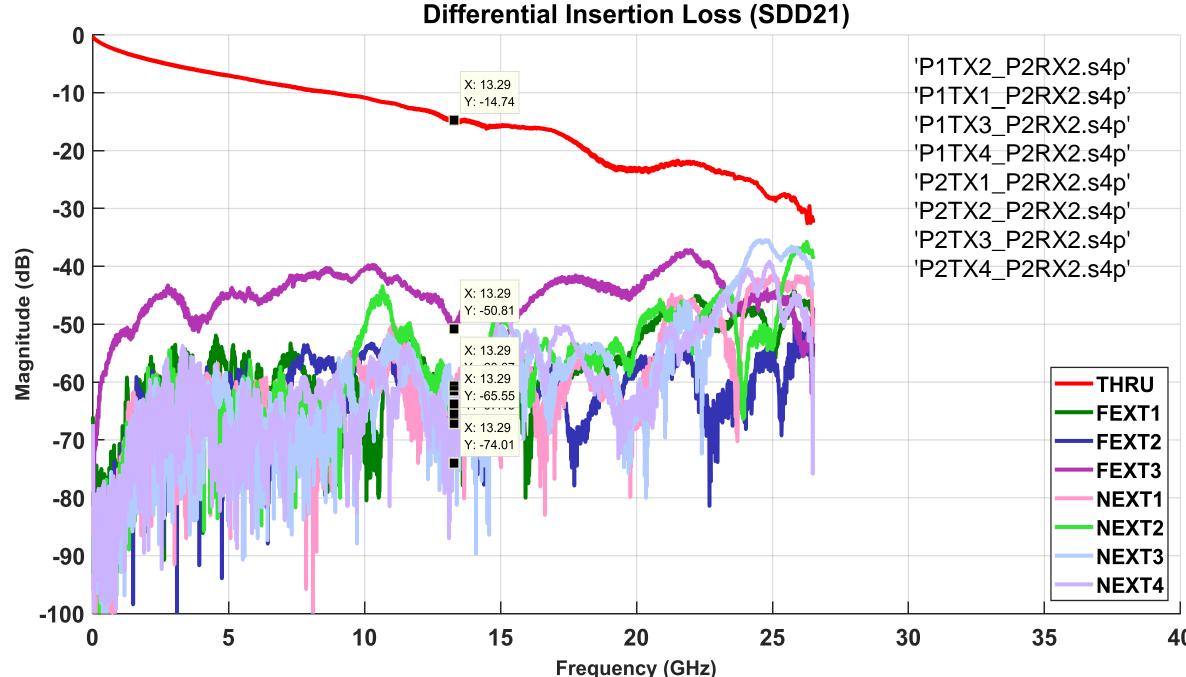




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**40** 

## **Amphenol QSFP to QSFP cable 3m 26awg cable**

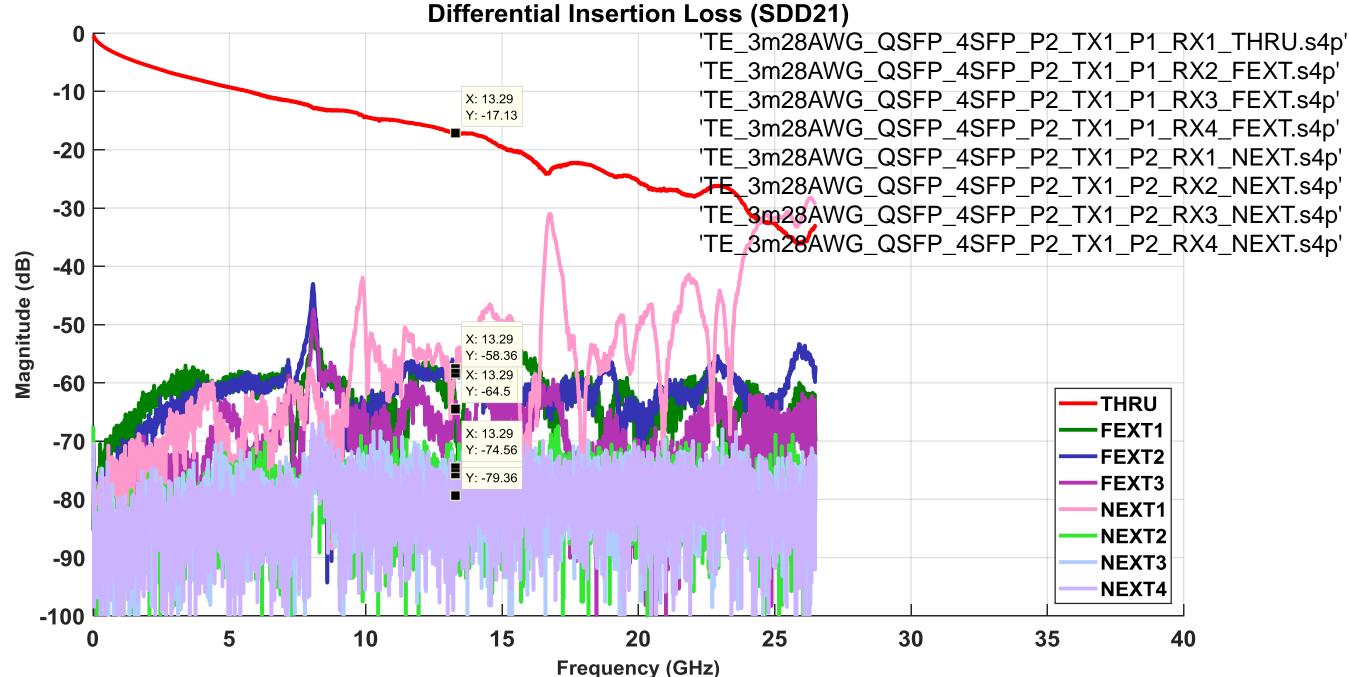


Transmitter Specifications and COM for 50GBASE-CR updated - dudek\_3cd\_01\_0118



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### **TE QSFP to Quad SFP cable 3m 28awg cable**







### 802.3cd COM table



## 802.3cd/D3.0 Table 136-15

	А	В	с	D	E	F	G	н	1	J	к	L
1		Table 93A-1 parameters	s			1	/O control			Table	93A–3 parameters	
2	Parameter	Setting	Units	Information		DIAGNOSTICS	0	logical		Parameter	Setting	Units
3	f_b	26.5625	GBd			DISPLAY_WINDOW	0	logical		package_tl_gamma0_a1_a2	[0 1.734e-3 1.455e-4]	
4	f_min	0.05	GHz			Display frequency domain	0	logical		package_tl_tau	6.141E-03	ns/mm
5	Delta_f	0.01	GHz			CSV_REPORT	0	logical		package_Z_c	90	Ohm (tdr sel)
6	C_d	[1.8e-4 1.8e-4]	nF	[TX RX]		RESULT_DIR	.\results\D1p3_{date}\					
7	z_p select	[12]		[test cases to run]		SAVE_FIGURES	0	logical		Table	92–12 parameters	
8	z_p (TX)	[12 30]	mm	[test cases]		Port Order	[1 3 2 4]			Parameter	Setting	
9	z_p (NEXT)	[12 12]	mm	[test cases]		RUNTAG	CR_50G_PAM4			board_tl_gamma0_a1_a2	[0 4.114e-4 2.547e-4]	
10	z_p (FEXT)	[12 30]	mm	[test cases]			eiver testing			board_tl_tau	6.191E-03	ns/mm
11	z_p (RX)	[12 30]	mm	[test cases]		RX_CALIBRATION	0	logical		board_Z_c	109.8	Ohm
12	C_p	[1.1e-4 1.1e-4]	nF	[TX RX]		Sigma BBN step	5.00E-03	V		z_bp (TX)	151	mm
13	R_0	50	Ohm			IDEAL_TX_TERM	0	logical		z_bp (NEXT)	110	mm
14	R_d	[ 55 55 ]		[TX RX] or selected		T_r	0.012	ns		z_bp (FEXT)	110	mm
15	f_r	0.75	*fb			FORCE_TR	1	logical		z_bp (RX)	151	mm
16	c(0)	0.6		min								
17	c(-1)	[-0.25:0.05:0]		[min:step:max]		Non stand	dard control options					
18	c(-2)	[0:0.025:0.1]		[min:step:max]		COM_CONTRIBUTION	0	logical				
19	c(1)	[-0.25:0.05:0]		[min:step:max]		TDR	1	logical				
20	g_DC	[-20:1:0]	dB	[min:step:max]		ERL	1	logical				
21	f_z	10.625	GHz			Z_t	50	ohms				
22	f_p1	10.625	GHz			ERL_ONLY	1	logical				
23	f_p2	53.125	GHz			TR_TDR	0.0189	ns				
24	A_v	0.45	V	tdr selected		TDR_duration	5					
25	A_fe	0.45	V	tdr selected		TDR_f_BT_3db	19.921875	GHz				
26	A_ne	0.63	V	tdr selected		TDR_Butterworth	1	logical				
27	L	4										
28	М	32										
29	N_b	12	UI									
30	b_max(1)	0.7										
31	b_max(2N_b)	0.2										
32	sigma_RJ	0.01	UI									
33	A_DD	0.02	UI									
34	eta_0	1.64E-08	V^2/GHz									
35	SNR_TX	32.5	dB	tdr selected								
36	R_LM	0.95										
37	DER_0	1.00E-04										
38		Operational control	1									
39	COM Pass threshold	3	dB									
40	Include PCB	1	Value	0, 1, 2								
41												
42	g_DC_HP	[-6:1:0]		[min:step:max]								
43	f_HP_PZ	0.6640625	GHz									



## 802.3cd/D3.0 Table 137-5

	А	В	с	D	E	F	G	н	1	J	К	L
1		Table 93A-1 parameters	5			l. I	/O control			Table	93A-3 parameters	
2	Parameter	Setting	Units	Information		DIAGNOSTICS	0	logical		Parameter	Setting	Units
3	f_b	26.5625	GBd			DISPLAY_WINDOW	0	logical		package_tl_gamma0_a1_a2	[0 1.734e-3 1.455e-4]	
4	f_min	0.05	GHz			Display frequency domain	0	logical		package_tl_tau	6.141E-03	ns/mm
5	Delta_f	0.01	GHz			CSV_REPORT	0	logical		package_Z_c	95	Ohm (tdr sel)
6	C_d	[1.8e-4 1.8e-4]	nF	[TX RX]		RESULT_DIR	.\results\D1p3_{date}\					
7	z_p select	[12]		[test cases to run]		SAVE_FIGURES	0	logical		Table	92–12 parameters	
8	z_p (TX)	[12 30]	mm	[test cases]		Port Order	[1 3 2 4]			Parameter	Setting	
9	z_p (NEXT)	[12 12]	mm	[test cases]		RUNTAG	CR_50G_PAM4			board_tl_gamma0_a1_a2	[0 4.114e-4 2.547e-4]	
10	z_p (FEXT)	[12 30]	mm	[test cases]		Rec	eiver testing			board_tl_tau	6.191E-03	ns/mm
11	z_p (RX)	[12 30]	mm	[test cases]		RX_CALIBRATION	0	logical		board_Z_c	109.8	Ohm
12	C_p	[1.1e-4 1.1e-4]	nF	[TX RX]		Sigma BBN step	5.00E-03	V		z_bp (TX)	151	mm
13	R_0	50	Ohm			IDEAL_TX_TERM	0	logical		z_bp (NEXT)	110	mm
14	R_d	[ 50 50 ]	Ohm	[TX RX] or selected		T_r	0.012	ns		z_bp (FEXT)	110	mm
15	f_r	0.75	*fb			FORCE_TR	1	logical		z_bp (RX)	151	mm
16	c(0)	0.6		min								
17	c(-1)	[-0.25:0.05:0]		[min:step:max]		Non stand	lard control options					
18	c(-2)	[0:0.025:0.1]		[min:step:max]		COM_CONTRIBUTION	0	logical				
19	c(1)	[-0.25:0.05:0]		[min:step:max]		TDR	1	logical				
20	g_DC	[-20:1:0]	dB	[min:step:max]		ERL	1	logical				
21	f_z	10.625	GHz			Z_t	50	ohms				
22	f_p1	10.625	GHz			ERL_ONLY	1	logical				
23	f_p2	53.125	GHz			TR_TDR	0.0189	ns				
24	A_v	0.415	V	tdr selected		TDR_duration	5					
25	A_fe	0.415	V	tdr selected		TDR_f_BT_3db	19.921875	GHz				
26	A_ne	0.604	v	tdr selected		TDR_Butterworth	1	logical				
27	L	4										
28	М	32										
29	N_b	12	UI									
30	b_max(1)	0.7										
31	b_max(2N_b)	0.2										
32	sigma_RJ	0.01	UI									
33	A_DD	0.02	UI									
34	eta_0	1.64E-08	V^2/GHz									
35	SNR_TX	32.5	dB	tdr selected								
36	R_LM	0.95										
37	DER_0	1.00E-04										
38		Operational control	1									
39	COM Pass threshold	3	dB									
40	Include PCB	1	Value	0, 1, 2								
41												
42	g_DC_HP	[-6:1:0]		[min:step:max]								
43	f_HP_PZ	0.6640625	GHz									





### 802.3by COM table



## 802.3by Table 110-11 CA-25G-N

	А	В	с	D	E	F	G	н	1	J	К	L
1		Table 93A-1 parameter	5			i,	O control			Table 9	3A-3 parameters	
2	Parameter	Setting	Units	Information		DIAGNOSTICS	1	logical		Parameter	Setting	Units
3	f_b	25.78125	GBd			DISPLAY_WINDOW	1	logical		package_tl_gamma0_a1_a2	[0 1.734e-3 1.455e-4]	
4	f_min	0.05	GHz			Display frequency domain	1	logical		package_tl_tau	6.141E-03	ns/mm
5	Delta_f	0.01	GHz			CSV_REPORT	1	logical		package_Z_c	78.2	Ohm
6	C_d	[2.5e-4 2.5e-4]	nF	[TX RX]		RESULT_DIR	.\results\test\					
7	z_p select	[12]		[test cases to run]		SAVE_FIGURES	0	logical		Table 9	2–12 parameters	
8	z_p (TX)	[12 30]	mm	[test cases]		SAVE_RESP	0	logical		Parameter	Setting	
9	z_p (NEXT)	[12 12]	mm	[test cases]		Port Order	[1 3 2 4]			board_tl_gamma0_a1_a2	[0 4.114e-4 2.547e-4]	
10	z_p (FEXT)	[12 30]	mm	[test cases]		RUNTAG	_CR_N			board_tl_tau	6.191E-03	ns/mm
11	z_p (RX)	[12 30]	mm	[test cases]		Rec	eiver testing			board_Z_c	109.8	Ohm
12	C_p	[1.8e-4 1.8e-4]	nF	[TX RX]		RX_CALIBRATION	0	logical		z_bp (TX)	151	mm
13	R_0	50	Ohm			Sigma BBN step	5.00E-03	V		z_bp (NEXT)	72	mm
14	R_d	[55 55]	Ohm	[TX RX]		IDEAL_TX_TERM	0	logical		z_bp (FEXT)	72	mm
15	f_r	0.75	*fb							z_bp (RX)	151	mm
16	c(0)	0.62		min								
17	c(-1)	[-0.18:0.02:0]		[min:step:max]		T_r	8.00E-03	ns				
18	c(1)	[-0.38:0.02:0]		[min:step:max]		T_r_meas_point	0	logical				
19	g_DC	[-16:1:0]	dB	[min:step:max]		T_r_filter_type	1	logical				
20	f_z	6.4453125	GHz									
21	f_p1	6.4453125	GHz			Non stand	ard control options					
22	f_p2	25.78125	GHz			INC_PACKAGE	1	logical				
23	A_v	0.4	V			IDEAL_RX_TERM	0	logical				
24	A_fe	0.6	V			INCLUDE_CTLE	1	logical				
25	A_ne	0.6	V			INCLUDE_TX_RX_FILTER	1	logical				
26	L	2										
27	М	32										
28	N_b	14	UI									
29	b_max(1)	0.35										
30	b_max(2N_b)	0.35										
31	sigma_RJ	0.01	UI									
32	A_DD	0.05	UI									
33	eta_0	5.20E-08	V^2/GHz									
34	SNR_TX	29	dB									
35	R_LM	1										
36	DER_0	1.00E-12										
37		Operational control										
38	COM Pass threshold	2.2	dB		set to 3 if ca	able loss than 12 dB						
39	Include PCB	1	Value	0, 1, 2								
40												



## 802.3by Table 110-11 CA-25G-S

	А	В	с	D	E	F	G	н	1	J	К	L
1		Table 93A-1 parameters	5			1	/O control			Table 9	3A–3 parameters	
2	Parameter	Setting	Units	Information		DIAGNOSTICS	1	logical		Parameter	Setting	Units
3	f_b	25.78125	GBd			DISPLAY_WINDOW	1	logical		package_tl_gamma0_a1_a2	[0 1.734e-3 1.455e-4]	
4	f_min	0.05	GHz			Display frequency domain	1	logical		package_tl_tau	6.141E-03	ns/mm
5	Delta_f	0.01	GHz			CSV_REPORT	1	logical		package_Z_c	78.2	Ohm
6	C_d	[2.5e-4 2.5e-4]	nF	[TX RX]		RESULT_DIR	.\results\test\					
7	z_p select	[12]		[test cases to run]		SAVE_FIGURES	0	logical		Table 9	2–12 parameters	
8	z_p (TX)	[12 30]	mm	[test cases]		SAVE_RESP	0	logical		Parameter	Setting	
9	z_p (NEXT)	[12 12]	mm	[test cases]		Port Order	[1 3 2 4]			board_tl_gamma0_a1_a2	[0 4.114e-4 2.547e-4]	
10	z_p (FEXT)	[12 30]	mm	[test cases]		RUNTAG	_CR_S			board_tl_tau	6.191E-03	ns/mm
11	z_p (RX)	[12 30]	mm	[test cases]		Rec	ceiver testing			board_Z_c	109.8	Ohm
12	C_p	[1.8e-4 1.8e-4]	nF	[TX RX]		RX_CALIBRATION	0	logical		z_bp (TX)	151	mm
13	R_0	50	Ohm			Sigma BBN step	5.00E-03	V		z_bp (NEXT)	72	mm
14	R_d	[55 55]	Ohm	[TX RX]		IDEAL_TX_TERM	0	logical		z_bp (FEXT)	72	mm
15	f_r	0.75	*fb							z_bp (RX)	151	mm
16	c(0)	0.62		min		T_r	8.00E-03	ns				
17	c(-1)	[-0.18:0.02:0]		[min:step:max]		T_r_meas_point	0	logical				
18	c(1)	[-0.38:0.02:0]		[min:step:max]		T_r_filter_type	1	logical				
19	g_DC	[-13:1:0]	dB	[min:step:max]								
20	f_z	6.4453125	GHz			Non stand	dard control options					
21	f_p1	6.4453125	GHz			INC_PACKAGE	1	logical				
22	f_p2	25.78125	GHz			IDEAL_RX_TERM	0	logical				
23	A_v	0.4	V			INCLUDE_CTLE	1	logical				
24	A_fe	0.6	V			INCLUDE_TX_RX_FILTER	1	logical				
25	A_ne	0.6	V									
26	L	2										
27	М	32										
28	N_b	14	UI									
29	b_max(1)	0.5										
30	b_max(2N_b)	0.5										
31	sigma_RJ	0.01	UI									
32	A_DD	0.05	UI									
33	eta_0	5.20E-08	V^2/GHz									
34	SNR_TX	29	dB									
35	R_LM	1										
36	DER_0	1.00E-08										
37		Operational control										
38	COM Pass threshold	3	dB									
39	Include PCB	1	Value	0, 1, 2								
10												



## 802.3by Table 110-11 CA-25G-L

	А	В	с	D	E	F	G	н	1	J	к	L
1		Table 93A-1 parameters	5			l, l,	/O control			Table 9	3A-3 parameters	
2	Parameter	Setting	Units	Information		DIAGNOSTICS	1	logical		Parameter	Setting	Units
3	f_b	25.78125	GBd			DISPLAY_WINDOW	1	logical		package_tl_gamma0_a1_a2	[0 1.734e-3 1.455e-4]	
4	f_min	0.05	GHz			Display frequency domain	1	logical		package_tl_tau	6.141E-03	ns/mm
5	Delta_f	0.01	GHz			CSV_REPORT	1	logical		package_Z_c	78.2	Ohm
6	C_d	[2.5e-4 2.5e-4]	nF	[TX RX]		RESULT_DIR	.\results\test\					
7	z_p select	[12]		[test cases to run]		SAVE_FIGURES	0	logical		Table 9	2–12 parameters	
8	z_p (TX)	[12 30]	mm	[test cases]		SAVE_RESP	0	logical		Parameter	Setting	
9	z_p (NEXT)	[12 12]	mm	[test cases]		Port Order	[1 3 2 4]			board_tl_gamma0_a1_a2	[0 4.114e-4 2.547e-4]	
10	z_p (FEXT)	[12 30]	mm	[test cases]		RUNTAG	_CR_L			board_tl_tau	6.191E-03	ns/mm
11	z_p (RX)	[12 30]	mm	[test cases]		Rec	eiver testing			board_Z_c	109.8	Ohm
12	C_p	[1.8e-4 1.8e-4]	nF	[TX RX]		RX_CALIBRATION	0	logical		z_bp (TX)	151	mm
13	R_0	50	Ohm			Sigma BBN step	5.00E-03	V		z_bp (NEXT)	72	mm
14	R_d	[55 55]	Ohm	[TX RX]		IDEAL_TX_TERM	0	logical		z_bp (FEXT)	72	mm
15	f_r	0.75	*fb							z_bp (RX)	151	mm
16	c(0)	0.62		min		T_r	8.00E-03	ns				
17	c(-1)	[-0.18:0.02:0]		[min:step:max]		T_r_meas_point	0	logical				
18	c(1)	[-0.38:0.02:0]		[min:step:max]		T_r_filter_type	1	logical				
19	g_DC	[-13:1:0]	dB	[min:step:max]								
20	f_z	6.4453125	GHz			Non stand	lard control options					
21	f_p1	6.4453125	GHz			INC_PACKAGE	1	logical				
22	f_p2	25.78125	GHz			IDEAL_RX_TERM	0	logical				
23	A_v	0.4	V			INCLUDE_CTLE	1	logical				
24	A_fe	0.6	V			INCLUDE_TX_RX_FILTER	1	logical				
25	A_ne	0.6	V									
26	L	2										
27	М	32										
28	N_b	14	UI									
29	b_max(1)	1										
30	b_max(2N_b)	1										
31	sigma_RJ	0.01	UI									
32	A_DD	0.05	UI									
33	eta_0	5.20E-08	V^2/GHz									
34	SNR_TX	29	dB									
35	R_LM	1										
36	DER_0	1.00E-05										
37		Operational control										
38	COM Pass threshold	3	dB									
39	Include PCB	1	Value	0, 1, 2								



## **References for cable s parameters**

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